ALUMINUM ELECTROLYTIC CAPACITORS

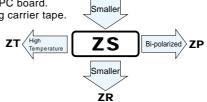
4.5mmL Chip Type







- Chip type with 4.5mm height.
- Designed for surface mounting on high density PC board.
- Applicable to automatic mounting machine using carrier tape.
- Adapted to the RoHS directive (2002/95/EC).



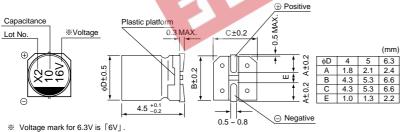
wx



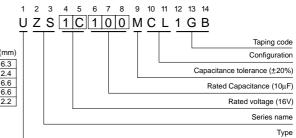
■Specifications

- Opcomoducióno												
Item	Performance Characteristics											
Category Temperature Range	-40 ~ + 85°C											
Rated Voltage Range	4 ~ 50V											
Rated Capacitance Range	0.1 ~ 220μF											
Capacitance Tolerance	±20% at 120Hz, 20°C											
Leakage Current	After 2 minutes' application of a	rated volta	ge, le	eakage c	urrent is	not more	than 0.01 C	V or 3 (μ	A) ,whiche	ver is greater.		
	Measurement frequency: 120Hz, Temperature: 20°C											
tan δ	Rated voltage (V)	4	6	.3	10	16	25	35	50			
	tan δ (MAX.)	0.50	0.:	30	0.24	0.19	0.16	0.14	0.14			
	Measurement frequency : 120Hz											
O. 1.111	Rated voltage (V)		4	6.3	10	16	25	35	50			
Stability at Low Temperature	Impedance ratio Z-25°C / Z+		7	4	3	2	2	2	2			
	ZT / Z20 (MAX.) Z-40°C / Z+	-20°C	15	8	8	4	4	3	3			
	After 2000 hours' application of		citance cl	tance change Within ±20% of initial value								
Endurance	at 85°C, capacitors meet the characteristics					tan δ 200% or less of initial specified value						
	requirements listed at right.		Leak	Leakage current Initial specified value or less								
<u> </u>	After storing the capacitors und	der no load	d at 85	5°C for 1	000 hou	s. and aft	er performin	ng voltage	e treatment	based on JIS C	5101-4	
Shelf Life	clause 4.1 at 20°C, they will me											
Resistance to soldering heat	The capacitors shall be kept on the hot plate maintained at 250°C Capacitance change Within ±10% of initial value											
	for 30 seconds. After removing from the hot plate and restored						tan δ Initial specified value or less					
	at room temperature, they meet t listed at right.	ine cnaract	eristic	requiren	nents	Leakag	je current		specified va			
Marking	Black print on the case top.											

■Chip Type



Type numbering system (Example : $16V 10\mu F$)



■ Dimensions

V		4	4	6.3		10		16		25		35		50	
Cap. (µF)	Code	0	G	C		1A		1C		1E		1V		1H	
0.1	0R1													4	1.0
0.22	R22		i		i		i		1					4	2.0
0.33	R33		!		ļ !		ļ		1					4	2.8
0.47	R47		i		İ		İ		i				i I	4	4.0
1	010				i !		ļ		1					4	8.4
2.2	2R2								i					4	13
3.3	3R3				ļ		ļ		1					4	17
4.7	4R7									4	16	4	18	5	20
10	100		i !		i !		i !	4	23	5	27	5	29	6.3	33
22	220		i	4	28	5	33	5	37	6.3	42	6.3	46		
33	330	4	28	5	37	5	41	6.3	49	6.3	52				
47	470	4	33	5	45	6.3	52	6.3	58						
100	101	5	56	6.3	70				İ						ļ
220	221	6.3	96											Case size	Rated

Rated Ripple (mArms) at 85°C 120Hz

Frequency coefficient of rated ripple current

or requested to the same of th										
Frequency	50 Hz	120 Hz	300 Hz	1 kHz	10 kHz~					
Coefficient	0.70	1.00	1.17	1.36	1.50					

- Taping specifications are given in page 24.
- Recommended land size, soldering by reflow are given in page 25, 26.
- Please select UR(p.70), UG(p.75) series if high C/V products are reqired.
 Please refer to page 3 for the minimum order quantity.